

# **MMBD4448**

# DISCRETE POWER AND SIGNAL TECHNOLOGIES

## **General Description:**

The high breakdown voltage, fast switching speed and high forward conductance of this diode packaged in a SOT-23 Surface Mount package makes it desirable also as a general purpose diode.

# **High Conductance Fast Diode**

### **Features:**

- 350 milliwatt Power Dissipation package.
- High Breakdown Voltage, Fast Switching Speed.
- Typical capacitance less than 1.5 picofarad.

# **Ordering:**

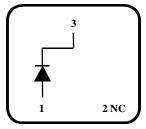
• 7 inch reel (178 mm); 8 mm Tape; 3,000 units per reel.

Absolute Maximum Ratings\* TA = 25°C unless otherwise noted

Sym	Parameter	Value	Units
$T_{stg}$	Storage Temperature	-55 to +150	°C
T <sub>J</sub>	Operating Junction Temperature	-55 to +150	оС
$P_{D}$	Total Power Dissipation at T <sub>A</sub> = 25°C	350	W
	Linear Derating Factor from T <sub>A</sub> = 25°C	2.8	mW/ <sup>o</sup> C
$R_{OJA}$	Thermal Resistance Junction-to-Ambient	357	°C/W
$W_{iv}$	Working Inverse Voltage	75	V
Io	Average Rectified Current	200	mA
I <sub>F</sub>	DC Forward Current (IF)	600	mA
i <sub>f</sub>	Recurrent Peak Forward Current (IF)	700	mA
i <sub>F(surge)</sub>	Peak Forward Surge Current (IFSM) Pulse Width = 1.0 second	1.0	Amp
	Pulse Width = 1.0 microsecond	2.0	Amp

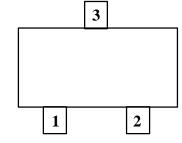
<sup>\*</sup>These ratings are limiting values above which the serviceability of any semiconductor device may be impaired

### CONNECTION DIAGRAMS



**PACKAGE** TO-236AB (Low)

Top Mark: RAB

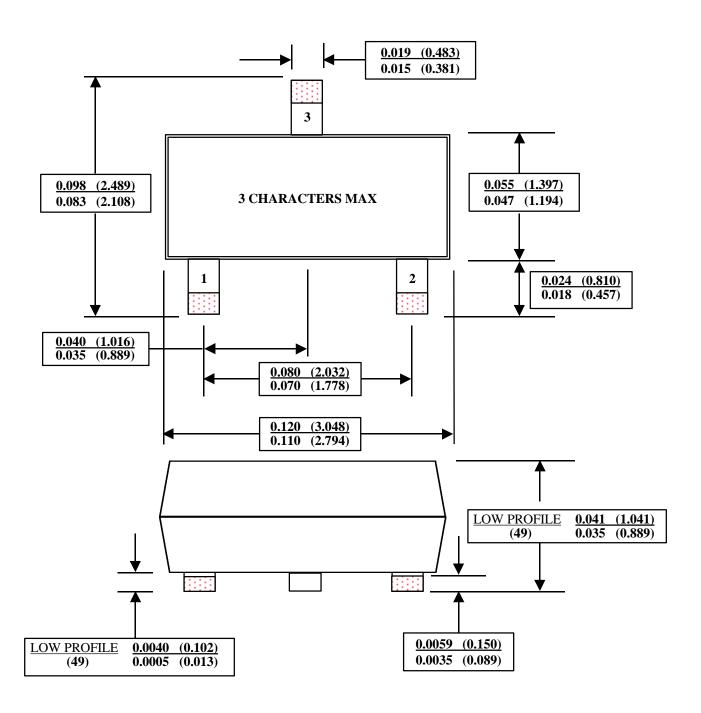


# **Electrical Characteristics**

TA = 25°C unless otherwise noted

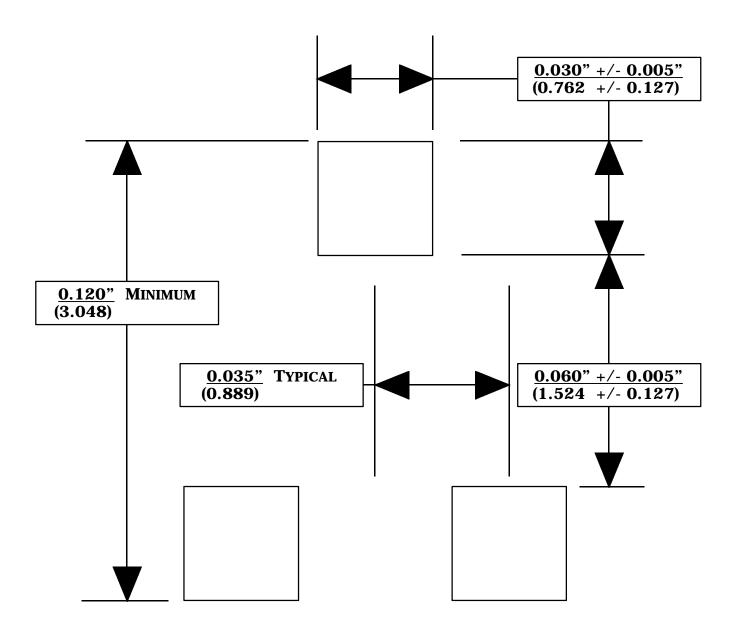
SYM	CHARACTERISTICS	MIN	MAX	UNITS	TEST CONDITIONS
B <sub>V</sub>	Breakdown Voltage 75	100		V V	$I_R = 100 \text{ uA}$ $I_R = 5.0 \text{ uA}$
I <sub>R</sub>	Reverse Leakage		25 50 5.0	nA uA uA	$V_{R} = 20 V$ $V_{R} = 20 V$ $V_{R} = 75 V$ $T_{A} = 150 \text{ Deg C}$
$V_{F}$	Forward Voltage	620	720 1.0	mV V	I <sub>F</sub> = 5 mA I <sub>F</sub> = 100 mA
C <sub>T</sub>	Capacitance		2.0	pF	V <sub>R</sub> = 0.0 V, f = 1.0 MHz
T <sub>RR</sub>	Reverse Recovery Time		4.0	ns	$I_F = 10 \text{ mA} \ I_R = 10 \text{ mA}$ $I_{RR} = 1.0 \text{ Ma}, \ R_L = 100 \text{ ohms}$
V <sub>FM</sub>	Peak Forward Recovery Voltage		2.5	V	I <sub>F</sub> = 50 mA Pk Square Wave





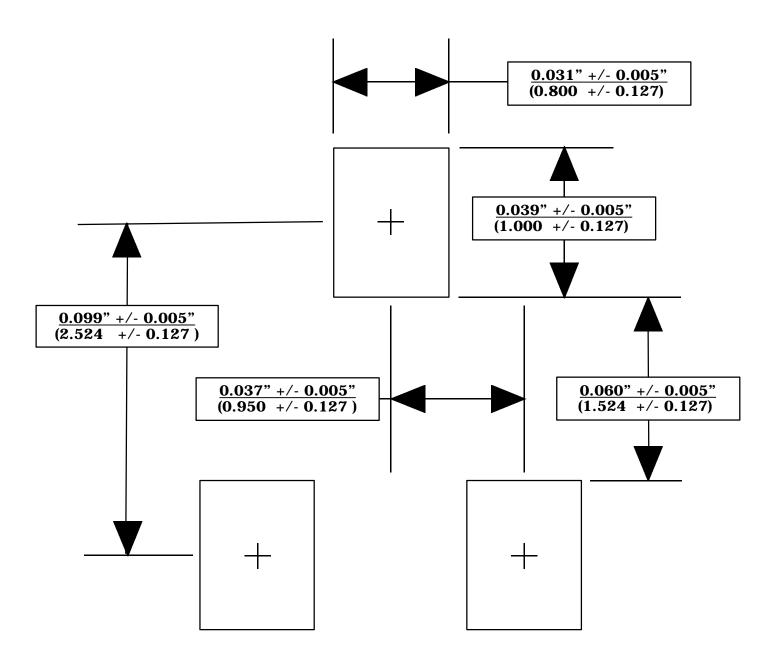
SOT-23
Diode (pinout)
TO-236AB (LOW PROFILE)
22-August-1994





RECOMMENDED SOLDER PADS FOR SOT-23





RECOMMENDED SOLDER PADS
FOR
U.S. & European SOT-23
&
Japanese SC-59

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